

Global Wafer Bonding System Market Professional Survey Report 2017

<https://marketpublishers.com/r/GA5B8C22071EN.html>

Date: December 2017

Pages: 106

Price: US\$ 3,500.00 (Single User License)

ID: GA5B8C22071EN

Abstracts

This report studies Wafer Bonding System in Global market, especially in North America, China, Europe, Southeast Asia, Japan and India, with production, revenue, consumption, import and export in these regions, from 2012 to 2016, and forecast to 2022.

This report focuses on top manufacturers in global market, with production, price, revenue and market share for each manufacturer, covering

Tokyo Electron(JP)

EV Group(AT)

SüSS MICROTEC SE(DE)

NxQ(US)

AYUMI INDUSTRY(JP)

Palomar Technologies(US)

Dynatex International(US)

Applied Microengineering(UK)

3M(US)

On the basis of product, this report displays the production, revenue, price, market share and growth rate of each type, primarily split into

Direct Bonding

Anodic Bonding

Solder/Eutectic/ Diffusion Bonding

Glass-Frit Bonding

Adhesive Bonding

Others

By Application, the market can be split into

Semiconductor

Solar Energy

Opto-electronic

MEMS

Others

By Regions, this report covers (we can add the regions/countries as you want)

North America

China

Europe

Southeast Asia

Japan

India

If you have any special requirements, please let us know and we will offer you the report as you want.

Contents

Global Wafer Bonding System Market Professional Survey Report 2017

1 INDUSTRY OVERVIEW OF WAFER BONDING SYSTEM

1.1 Definition and Specifications of Wafer Bonding System

1.1.1 Definition of Wafer Bonding System

1.1.2 Specifications of Wafer Bonding System

1.2 Classification of Wafer Bonding System

1.2.1 Direct Bonding

1.2.2 Anodic Bonding

1.2.3 Solder/Eutectic/ Diffusion Bonding

1.2.4 Glass-Frit Bonding

1.2.5 Adhesive Bonding

1.2.6 Others

1.3 Applications of Wafer Bonding System

1.3.1 Semiconductor

1.3.2 Solar Energy

1.3.3 Opto-electronic

1.3.4 MEMS

1.3.5 Others

1.4 Market Segment by Regions

1.4.1 North America

1.4.2 China

1.4.3 Europe

1.4.4 Southeast Asia

1.4.5 Japan

1.4.6 India

2 MANUFACTURING COST STRUCTURE ANALYSIS OF WAFER BONDING SYSTEM

2.1 Raw Material and Suppliers

2.2 Manufacturing Cost Structure Analysis of Wafer Bonding System

2.3 Manufacturing Process Analysis of Wafer Bonding System

2.4 Industry Chain Structure of Wafer Bonding System

3 TECHNICAL DATA AND MANUFACTURING PLANTS ANALYSIS OF WAFER

BONDING SYSTEM

3.1 Capacity and Commercial Production Date of Global Wafer Bonding System Major Manufacturers in 2016

3.2 Manufacturing Plants Distribution of Global Wafer Bonding System Major Manufacturers in 2016

3.3 R&D Status and Technology Source of Global Wafer Bonding System Major Manufacturers in 2016

3.4 Raw Materials Sources Analysis of Global Wafer Bonding System Major Manufacturers in 2016

4 GLOBAL WAFER BONDING SYSTEM OVERALL MARKET OVERVIEW

4.1 2012-2017E Overall Market Analysis

4.2 Capacity Analysis

4.2.1 2012-2017E Global Wafer Bonding System Capacity and Growth Rate Analysis

4.2.2 2016 Wafer Bonding System Capacity Analysis (Company Segment)

4.3 Sales Analysis

4.3.1 2012-2017E Global Wafer Bonding System Sales and Growth Rate Analysis

4.3.2 2016 Wafer Bonding System Sales Analysis (Company Segment)

4.4 Sales Price Analysis

4.4.1 2012-2017E Global Wafer Bonding System Sales Price

4.4.2 2016 Wafer Bonding System Sales Price Analysis (Company Segment)

5 WAFER BONDING SYSTEM REGIONAL MARKET ANALYSIS

5.1 North America Wafer Bonding System Market Analysis

5.1.1 North America Wafer Bonding System Market Overview

5.1.2 North America 2012-2017E Wafer Bonding System Local Supply, Import, Export, Local Consumption Analysis

5.1.3 North America 2012-2017E Wafer Bonding System Sales Price Analysis

5.1.4 North America 2016 Wafer Bonding System Market Share Analysis

5.2 China Wafer Bonding System Market Analysis

5.2.1 China Wafer Bonding System Market Overview

5.2.2 China 2012-2017E Wafer Bonding System Local Supply, Import, Export, Local Consumption Analysis

5.2.3 China 2012-2017E Wafer Bonding System Sales Price Analysis

5.2.4 China 2016 Wafer Bonding System Market Share Analysis

5.3 Europe Wafer Bonding System Market Analysis

- 5.3.1 Europe Wafer Bonding System Market Overview
- 5.3.2 Europe 2012-2017E Wafer Bonding System Local Supply, Import, Export, Local Consumption Analysis
- 5.3.3 Europe 2012-2017E Wafer Bonding System Sales Price Analysis
- 5.3.4 Europe 2016 Wafer Bonding System Market Share Analysis
- 5.4 Southeast Asia Wafer Bonding System Market Analysis
 - 5.4.1 Southeast Asia Wafer Bonding System Market Overview
 - 5.4.2 Southeast Asia 2012-2017E Wafer Bonding System Local Supply, Import, Export, Local Consumption Analysis
 - 5.4.3 Southeast Asia 2012-2017E Wafer Bonding System Sales Price Analysis
 - 5.4.4 Southeast Asia 2016 Wafer Bonding System Market Share Analysis
- 5.5 Japan Wafer Bonding System Market Analysis
 - 5.5.1 Japan Wafer Bonding System Market Overview
 - 5.5.2 Japan 2012-2017E Wafer Bonding System Local Supply, Import, Export, Local Consumption Analysis
 - 5.5.3 Japan 2012-2017E Wafer Bonding System Sales Price Analysis
 - 5.5.4 Japan 2016 Wafer Bonding System Market Share Analysis
- 5.6 India Wafer Bonding System Market Analysis
 - 5.6.1 India Wafer Bonding System Market Overview
 - 5.6.2 India 2012-2017E Wafer Bonding System Local Supply, Import, Export, Local Consumption Analysis
 - 5.6.3 India 2012-2017E Wafer Bonding System Sales Price Analysis
 - 5.6.4 India 2016 Wafer Bonding System Market Share Analysis

6 GLOBAL 2012-2017E WAFER BONDING SYSTEM SEGMENT MARKET ANALYSIS (BY TYPE)

- 6.1 Global 2012-2017E Wafer Bonding System Sales by Type
- 6.2 Different Types of Wafer Bonding System Product Interview Price Analysis
- 6.3 Different Types of Wafer Bonding System Product Driving Factors Analysis
 - 6.3.1 Direct Bonding of Wafer Bonding System Growth Driving Factor Analysis
 - 6.3.2 Anodic Bonding of Wafer Bonding System Growth Driving Factor Analysis
 - 6.3.3 Solder/Eutectic/ Diffusion Bonding of Wafer Bonding System Growth Driving Factor Analysis
 - 6.3.4 Glass-Frit Bonding of Wafer Bonding System Growth Driving Factor Analysis
 - 6.3.5 Adhesive Bonding of Wafer Bonding System Growth Driving Factor Analysis
 - 6.3.6 Others of Wafer Bonding System Growth Driving Factor Analysis

7 GLOBAL 2012-2017E WAFER BONDING SYSTEM SEGMENT MARKET

ANALYSIS (BY APPLICATION)

- 7.1 Global 2012-2017E Wafer Bonding System Consumption by Application
- 7.2 Different Application of Wafer Bonding System Product Interview Price Analysis
- 7.3 Different Application of Wafer Bonding System Product Driving Factors Analysis
 - 7.3.1 Semiconductor of Wafer Bonding System Growth Driving Factor Analysis
 - 7.3.2 Solar Energy of Wafer Bonding System Growth Driving Factor Analysis
 - 7.3.3 Opto-electronic of Wafer Bonding System Growth Driving Factor Analysis
 - 7.3.4 MEMS of Wafer Bonding System Growth Driving Factor Analysis
 - 7.3.5 Others of Wafer Bonding System Growth Driving Factor Analysis

8 MAJOR MANUFACTURERS ANALYSIS OF WAFER BONDING SYSTEM

8.1 Tokyo Electron(JP)

- 8.1.1 Company Profile
- 8.1.2 Product Picture and Specifications
 - 8.1.2.1 Product A
 - 8.1.2.2 Product B
- 8.1.3 Tokyo Electron(JP) 2016 Wafer Bonding System Sales, Ex-factory Price, Revenue, Gross Margin Analysis
- 8.1.4 Tokyo Electron(JP) 2016 Wafer Bonding System Business Region Distribution Analysis

8.2 EV Group(AT)

- 8.2.1 Company Profile
- 8.2.2 Product Picture and Specifications
 - 8.2.2.1 Product A
 - 8.2.2.2 Product B
- 8.2.3 EV Group(AT) 2016 Wafer Bonding System Sales, Ex-factory Price, Revenue, Gross Margin Analysis
- 8.2.4 EV Group(AT) 2016 Wafer Bonding System Business Region Distribution Analysis

8.3 SüSS MICROTEC SE(DE)

- 8.3.1 Company Profile
- 8.3.2 Product Picture and Specifications
 - 8.3.2.1 Product A
 - 8.3.2.2 Product B
- 8.3.3 SüSS MICROTEC SE(DE) 2016 Wafer Bonding System Sales, Ex-factory Price, Revenue, Gross Margin Analysis
- 8.3.4 SüSS MICROTEC SE(DE) 2016 Wafer Bonding System Business Region

Distribution Analysis

8.4 NxQ(US)

8.4.1 Company Profile

8.4.2 Product Picture and Specifications

8.4.2.1 Product A

8.4.2.2 Product B

8.4.3 NxQ(US) 2016 Wafer Bonding System Sales, Ex-factory Price, Revenue, Gross Margin Analysis

8.4.4 NxQ(US) 2016 Wafer Bonding System Business Region Distribution Analysis

8.5 AYUMI INDUSTRY(JP)

8.5.1 Company Profile

8.5.2 Product Picture and Specifications

8.5.2.1 Product A

8.5.2.2 Product B

8.5.3 AYUMI INDUSTRY(JP) 2016 Wafer Bonding System Sales, Ex-factory Price, Revenue, Gross Margin Analysis

8.5.4 AYUMI INDUSTRY(JP) 2016 Wafer Bonding System Business Region

Distribution Analysis

8.6 Palomar Technologies(US)

8.6.1 Company Profile

8.6.2 Product Picture and Specifications

8.6.2.1 Product A

8.6.2.2 Product B

8.6.3 Palomar Technologies(US) 2016 Wafer Bonding System Sales, Ex-factory Price, Revenue, Gross Margin Analysis

8.6.4 Palomar Technologies(US) 2016 Wafer Bonding System Business Region

Distribution Analysis

8.7 Dynatex International(US)

8.7.1 Company Profile

8.7.2 Product Picture and Specifications

8.7.2.1 Product A

8.7.2.2 Product B

8.7.3 Dynatex International(US) 2016 Wafer Bonding System Sales, Ex-factory Price, Revenue, Gross Margin Analysis

8.7.4 Dynatex International(US) 2016 Wafer Bonding System Business Region

Distribution Analysis

8.8 Applied Microengineering(UK)

8.8.1 Company Profile

8.8.2 Product Picture and Specifications

8.8.2.1 Product A

8.8.2.2 Product B

8.8.3 Applied Microengineering(UK) 2016 Wafer Bonding System Sales, Ex-factory Price, Revenue, Gross Margin Analysis

8.8.4 Applied Microengineering(UK) 2016 Wafer Bonding System Business Region Distribution Analysis

8.9 3M(US)

8.9.1 Company Profile

8.9.2 Product Picture and Specifications

8.9.2.1 Product A

8.9.2.2 Product B

8.9.3 3M(US) 2016 Wafer Bonding System Sales, Ex-factory Price, Revenue, Gross Margin Analysis

8.9.4 3M(US) 2016 Wafer Bonding System Business Region Distribution Analysis

9 DEVELOPMENT TREND OF ANALYSIS OF WAFER BONDING SYSTEM MARKET

9.1 Global Wafer Bonding System Market Trend Analysis

9.1.1 Global 2017-2022 Wafer Bonding System Market Size (Volume and Value) Forecast

9.1.2 Global 2017-2022 Wafer Bonding System Sales Price Forecast

9.2 Wafer Bonding System Regional Market Trend

9.2.1 North America 2017-2022 Wafer Bonding System Consumption Forecast

9.2.2 China 2017-2022 Wafer Bonding System Consumption Forecast

9.2.3 Europe 2017-2022 Wafer Bonding System Consumption Forecast

9.2.4 Southeast Asia 2017-2022 Wafer Bonding System Consumption Forecast

9.2.5 Japan 2017-2022 Wafer Bonding System Consumption Forecast

9.2.6 India 2017-2022 Wafer Bonding System Consumption Forecast

9.3 Wafer Bonding System Market Trend (Product Type)

9.4 Wafer Bonding System Market Trend (Application)

10 WAFER BONDING SYSTEM MARKETING TYPE ANALYSIS

10.1 Wafer Bonding System Regional Marketing Type Analysis

10.2 Wafer Bonding System International Trade Type Analysis

10.3 Traders or Distributors with Contact Information of Wafer Bonding System by Region

10.4 Wafer Bonding System Supply Chain Analysis

11 CONSUMERS ANALYSIS OF WAFER BONDING SYSTEM

11.1 Consumer 1 Analysis

11.2 Consumer 2 Analysis

11.3 Consumer 3 Analysis

11.4 Consumer 4 Analysis

12 CONCLUSION OF THE GLOBAL WAFER BONDING SYSTEM MARKET PROFESSIONAL SURVEY REPORT 2017

Methodology

Analyst Introduction

Data Source

The report requires updating with new data and is sent in 2-3 business days after order is placed.

List Of Tables

LIST OF TABLES AND FIGURES

Figure Picture of Wafer Bonding System
Table Product Specifications of Wafer Bonding System
Table Classification of Wafer Bonding System
Figure Global Production Market Share of Wafer Bonding System by Type in 2016
Figure Direct Bonding Picture
Table Major Manufacturers of Direct Bonding
Figure Anodic Bonding Picture
Table Major Manufacturers of Anodic Bonding
Figure Solder/Eutectic/ Diffusion Bonding Picture
Table Major Manufacturers of Solder/Eutectic/ Diffusion Bonding
Figure Glass-Frit Bonding Picture
Table Major Manufacturers of Glass-Frit Bonding
Figure Adhesive Bonding Picture
Table Major Manufacturers of Adhesive Bonding
Figure Others Picture
Table Major Manufacturers of Others
Table Applications of Wafer Bonding System
Figure Global Consumption Volume Market Share of Wafer Bonding System by Application in 2016
Figure Semiconductor Examples
Table Major Consumers in Semiconductor
Figure Solar Energy Examples
Table Major Consumers in Solar Energy
Figure Opto-electronic Examples
Table Major Consumers in Opto-electronic
Figure MEMS Examples
Table Major Consumers in MEMS
Figure Others Examples
Table Major Consumers in Others
Figure Market Share of Wafer Bonding System by Regions
Figure North America Wafer Bonding System Market Size (Million USD) (2012-2022)
Figure China Wafer Bonding System Market Size (Million USD) (2012-2022)
Figure Europe Wafer Bonding System Market Size (Million USD) (2012-2022)
Figure Southeast Asia Wafer Bonding System Market Size (Million USD) (2012-2022)
Figure Japan Wafer Bonding System Market Size (Million USD) (2012-2022)

Figure India Wafer Bonding System Market Size (Million USD) (2012-2022)
Table Wafer Bonding System Raw Material and Suppliers
Table Manufacturing Cost Structure Analysis of Wafer Bonding System in 2016
Figure Manufacturing Process Analysis of Wafer Bonding System
Figure Industry Chain Structure of Wafer Bonding System
Table Capacity and Commercial Production Date of Global Wafer Bonding System Major Manufacturers in 2016
Table Manufacturing Plants Distribution of Global Wafer Bonding System Major Manufacturers in 2016
Table R&D Status and Technology Source of Global Wafer Bonding System Major Manufacturers in 2016
Table Raw Materials Sources Analysis of Global Wafer Bonding System Major Manufacturers in 2016
Table Global Capacity, Sales, Price, Cost, Sales Revenue (M USD) and Gross Margin of Wafer Bonding System 2012-2017
Figure Global 2012-2017E Wafer Bonding System Market Size (Volume) and Growth Rate
Figure Global 2012-2017E Wafer Bonding System Market Size (Value) and Growth Rate
Table 2012-2017E Global Wafer Bonding System Capacity and Growth Rate
Table 2016 Global Wafer Bonding System Capacity (K Units) List (Company Segment)
Table 2012-2017E Global Wafer Bonding System Sales (K Units) and Growth Rate
Table 2016 Global Wafer Bonding System Sales (K Units) List (Company Segment)
Table 2012-2017E Global Wafer Bonding System Sales Price (USD/Unit)
Table 2016 Global Wafer Bonding System Sales Price (USD/Unit) List (Company Segment)
Figure North America Capacity Overview
Table North America Supply, Import, Export and Consumption (K Units) of Wafer Bonding System 2012-2017E
Figure North America 2012-2017E Wafer Bonding System Sales Price (USD/Unit)
Figure North America 2016 Wafer Bonding System Sales Market Share
Figure China Capacity Overview
Table China Supply, Import, Export and Consumption (K Units) of Wafer Bonding System 2012-2017E
Figure China 2012-2017E Wafer Bonding System Sales Price (USD/Unit)
Figure China 2016 Wafer Bonding System Sales Market Share
Figure Europe Capacity Overview
Table Europe Supply, Import, Export and Consumption (K Units) of Wafer Bonding System 2012-2017E

Figure Europe 2012-2017E Wafer Bonding System Sales Price (USD/Unit)
Figure Europe 2016 Wafer Bonding System Sales Market Share
Figure Southeast Asia Capacity Overview
Table Southeast Asia Supply, Import, Export and Consumption (K Units) of Wafer Bonding System 2012-2017E
Figure Southeast Asia 2012-2017E Wafer Bonding System Sales Price (USD/Unit)
Figure Southeast Asia 2016 Wafer Bonding System Sales Market Share
Figure Japan Capacity Overview
Table Japan Supply, Import, Export and Consumption (K Units) of Wafer Bonding System 2012-2017E
Figure Japan 2012-2017E Wafer Bonding System Sales Price (USD/Unit)
Figure Japan 2016 Wafer Bonding System Sales Market Share
Figure India Capacity Overview
Table India Supply, Import, Export and Consumption (K Units) of Wafer Bonding System 2012-2017E
Figure India 2012-2017E Wafer Bonding System Sales Price (USD/Unit)
Figure India 2016 Wafer Bonding System Sales Market Share
Table Global 2012-2017E Wafer Bonding System Sales (K Units) by Type
Table Different Types Wafer Bonding System Product Interview Price
Table Global 2012-2017E Wafer Bonding System Sales (K Units) by Application
Table Different Application Wafer Bonding System Product Interview Price
Table Tokyo Electron(JP) Information List
Table Product A Overview
Table Product B Overview
Table 2016 Tokyo Electron(JP) Wafer Bonding System Revenue (Million USD), Sales (K Units), Ex-factory Price (USD/Unit)
Figure 2016 Tokyo Electron(JP) Wafer Bonding System Business Region Distribution
Table EV Group(AT) Information List
Table Product A Overview
Table Product B Overview
Table 2016 EV Group(AT) Wafer Bonding System Revenue (Million USD), Sales (K Units), Ex-factory Price (USD/Unit)
Figure 2016 EV Group(AT) Wafer Bonding System Business Region Distribution
Table SüSS MICROTEC SE(DE) Information List
Table Product A Overview
Table Product B Overview
Table 2015 SüSS MICROTEC SE(DE) Wafer Bonding System Revenue (Million USD), Sales (K Units), Ex-factory Price (USD/Unit)
Figure 2016 SüSS MICROTEC SE(DE) Wafer Bonding System Business Region

Distribution

Table NxQ(US) Information List

Table Product A Overview

Table Product B Overview

Table 2016 NxQ(US) Wafer Bonding System Revenue (Million USD), Sales (K Units), Ex-factory Price (USD/Unit)

Figure 2016 NxQ(US) Wafer Bonding System Business Region Distribution

Table AYUMI INDUSTRY(JP) Information List

Table Product A Overview

Table Product B Overview

Table 2016 AYUMI INDUSTRY(JP) Wafer Bonding System Revenue (Million USD), Sales (K Units), Ex-factory Price (USD/Unit)

Figure 2016 AYUMI INDUSTRY(JP) Wafer Bonding System Business Region Distribution

Table Palomar Technologies(US) Information List

Table Product A Overview

Table Product B Overview

Table 2016 Palomar Technologies(US) Wafer Bonding System Revenue (Million USD), Sales (K Units), Ex-factory Price (USD/Unit)

Figure 2016 Palomar Technologies(US) Wafer Bonding System Business Region Distribution

Table Dynatex International(US) Information List

Table Product A Overview

Table Product B Overview

Table 2016 Dynatex International(US) Wafer Bonding System Revenue (Million USD), Sales (K Units), Ex-factory Price (USD/Unit)

Figure 2016 Dynatex International(US) Wafer Bonding System Business Region Distribution

Table Applied Microengineering(UK) Information List

Table Product A Overview

Table Product B Overview

Table 2016 Applied Microengineering(UK) Wafer Bonding System Revenue (Million USD), Sales (K Units), Ex-factory Price (USD/Unit)

Figure 2016 Applied Microengineering(UK) Wafer Bonding System Business Region Distribution

Table 3M(US) Information List

Table Product A Overview

Table Product B Overview

Table 2016 3M(US) Wafer Bonding System Revenue (Million USD), Sales (K Units), Ex-

factory Price (USD/Unit)

Figure 2016 3M(US) Wafer Bonding System Business Region Distribution

Figure Global 2017-2022 Wafer Bonding System Market Size (K Units) and Growth Rate Forecast

Figure Global 2017-2022 Wafer Bonding System Market Size (Million USD) and Growth Rate Forecast

Figure Global 2017-2022 Wafer Bonding System Sales Price (USD/Unit) Forecast

Figure North America 2017-2022 Wafer Bonding System Consumption Volume (K Units) and Growth Rate Forecast

Figure China 2017-2022 Wafer Bonding System Consumption Volume (K Units) and Growth Rate Forecast

Figure Europe 2017-2022 Wafer Bonding System Consumption Volume (K Units) and Growth Rate Forecast

Figure Southeast Asia 2017-2022 Wafer Bonding System Consumption Volume (K Units) and Growth Rate Forecast

Figure Japan 2017-2022 Wafer Bonding System Consumption Volume (K Units) and Growth Rate Forecast

Figure India 2017-2022 Wafer Bonding System Consumption Volume (K Units) and Growth Rate Forecast

Table Global Sales Volume (K Units) of Wafer Bonding System by Type 2017-2022

Table Global Consumption Volume (K Units) of Wafer Bonding System by Application 2017-2022

Table Traders or Distributors with Contact Information of Wafer Bonding System by Region

I would like to order

Product name: Global Wafer Bonding System Market Professional Survey Report 2017

Product link: <https://marketpublishers.com/r/GA5B8C22071EN.html>

Price: US\$ 3,500.00 (Single User License / Electronic Delivery)

If you want to order Corporate License or Hard Copy, please, contact our Customer Service:

info@marketpublishers.com

Payment

To pay by Credit Card (Visa, MasterCard, American Express, PayPal), please, click button on product page <https://marketpublishers.com/r/GA5B8C22071EN.html>

To pay by Wire Transfer, please, fill in your contact details in the form below:

First name:
Last name:
Email:
Company:
Address:
City:
Zip code:
Country:
Tel:
Fax:
Your message:

****All fields are required**

Customer signature _____

Please, note that by ordering from marketpublishers.com you are agreeing to our Terms & Conditions at <https://marketpublishers.com/docs/terms.html>

To place an order via fax simply print this form, fill in the information below and fax the completed form to +44 20 7900 3970